Product Preview

Sensitive Gate Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed and tested for repetitive peak operation required for CD ignition, fuel ignitors, flash circuits, motor controls and low-power switching applications.

Features

- Blocking Voltage to 600 V
- High Surge Current 15 A
- Very Low Forward "On" Voltage at High Current
- Low-Cost Surface Mount SOT-223 Package
- These are Pb-Free Devices

MAXIMUM RATINGS (T_{.I} = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|---------------------------------------|------------------|------------------|
| Peak Repetitive Off-State Voltage (Note 1) (R _{GK} = IK, T _J = -40 to +110°C, Sine Wave, 50 to 60 Hz, Gate Open) NYC222 NYC226 NYC228 | V _{DRM,} V _{RRM} | 50 400 600 | V |
| On-State Current RMS (180° Conduction Angles, T _C = 80°C) | I _{T(RMS)} | 1.5 | Α |
| Peak Non-repetitive Surge Current, @T _A = 25°C, (1/2 Cycle, Sine Wave, 60 Hz) | I _{TSM} | 15 | Α |
| Circuit Fusing Considerations (t = 8.3 ms) | I ² t | 0.9 | A ² s |
| Forward Peak Gate Power (Pulse Width ≤ 1.0 μsec, T _A = 25°C) | P _{GM} | 0.5 | W |
| Forward Average Gate Power (t = 8.3 msec, T _A = 25°C) | P _{G(AV)} | 0.1 | W |
| Forward Peak Gate Current (Pulse Width ≤ 1.0 μs, T _A = 25°C) | I _{FGM} | 0.2 | Α |
| Reverse Peak Gate Voltage (Pulse Width ≤ 1.0 μs, T _A = 25°C) | V _{RGM} | 5.0 | V |
| Operating Junction Temperature Range @ Rated V _{RRM} and V _{DRM} | TJ | -40 to +110 | °C |
| Storage Temperature Range | T _{stg} | -40 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

 V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

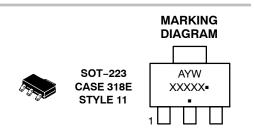


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SCRs 1.5 AMPERES RMS 400 thru 600 VOLTS





A = Assembly Location

Y = Year W = Work Week XXXXX = Device Code • = Pb-Free Package

(Note: Microdot may be in either location)

| PIN ASSIGNMENT | | | | |
|----------------|-------------|--|--|--|
| 1 | K (Cathode) | | | |
| 2 | A (Anode) | | | |
| 3 | G (Gate) | | | |
| 4 | A (Anode) | | | |

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------|----------------------|-----------------------|
| NYC222STT1G | SOT-223 (Pb-Free) | 1000 /Tape & Reel |
| NYC226STT1G | SOT-223 (Pb-Free) | 1000 /Tape & Reel |
| NYC228STT1G | SOT-223 (Pb-Free) | 1000 /Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

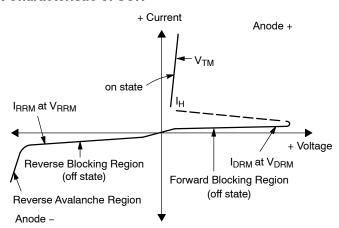
| Characteristic | Symbol | Max | Unit |
|---|----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient PCB Mounted | $R_{	heta JA}$ | 156 | °C/W |
| Thermal Resistance, Junction-to-Tab Measured on MT2 Tab Adjacent to Epoxy | $R_{	heta JT}$ | 25 | °C/W |
| Maximum Device Temperature for Soldering Purposes for 10 Secs Maximum | TL | 260 | °C |

ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted.)

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|---|---|-------------------------------------|--------|---------|------------|--------------------------|
| OFF CHARACTERISTICS | | | | • | • | |
| Peak Repetitive Forward or Reverse Blocking Current (V_{AK} = Rated V_{DRM}/V_{RRM} ; R_{GK} = 1000 Ω) | T _C = 25°C T _C = 110°C | I _{DRM} , I _{RRM} | - - | _ _ | 10 200 | μ Α μ Α |
| ON CHARACTERISTICS | | | | | | |
| Peak Forward On-State Voltage (Note 2) (I _{TM} = 1 A Peak) | | V _{TM} | - | 1.2 | 1.7 | V |
| Gate Trigger Current (dc) (Note 3) $(V_{AK} = 6 \text{ Vdc}, R_L = 100 \Omega)$ | $T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$ | l _{GT} | - | 30 - | 200 500 | μΑ |
| Gate Trigger Voltage (dc) (Note 3) $(V_{AK} = 7 \text{ Vdc}, R_L = 100 \Omega)$ | $T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$ | V _{GT} | - | - - | 0.8 1.2 | V |
| Gate Non-Trigger Voltage $(V_{AK} = V_{DRM}, R_L = 100 \Omega)$ | T _C = 110°C | V _{GD} | 0.1 | - | - | V |
| Holding Current (V_{AK} = 12 V, R_{GK} = 1000 Ω) Initiating Current = 200 mA | T _C = 25°C T _C = -40°C | I _H | - - | 2.0 | 5.0 10 | mA |
| DYNAMIC CHARACTERISTICS | | | | | | • |
| Critical Rate of Rise of Off–State Voltage (T _C = 110°C) | | dv/dt | - | 25 | _ | V/μs |

Voltage Current Characteristic of SCR

| Symbol | Parameter |
|------------------|---|
| V_{DRM} | Peak Repetitive Off State Forward Voltage |
| I _{DRM} | Peak Forward Blocking Current |
| V_{RRM} | Peak Repetitive Off State Reverse Voltage |
| I _{RRM} | Peak Reverse Blocking Current |
| V_{TM} | Peak on State Voltage |
| I _H | Holding Current |



Pulse Width = 1.0 ms, Duty Cycle ≤ 1%.
 R_{GK} Current not included in measurement.

CURRENT DERATING

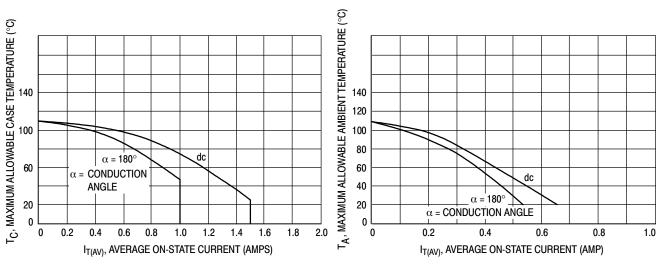


Figure 1. Maximum Case Temperature

Figure 2. Maximum Ambient Temperature

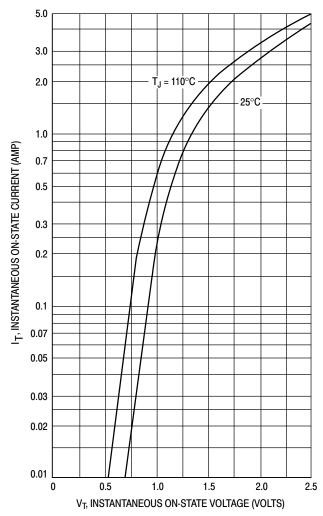


Figure 3. Typical Forward Voltage

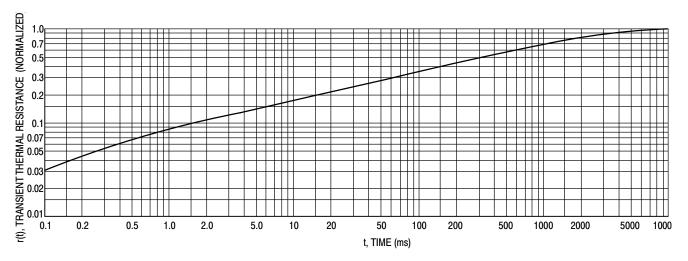


Figure 4. Thermal Response

TYPICAL CHARACTERISTICS

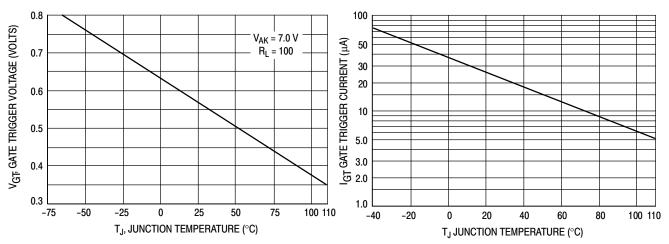


Figure 5. Typical Gate Trigger Voltage

Figure 6. Typical Gate Trigger Current

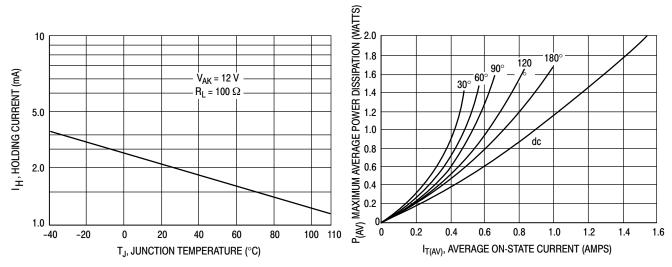
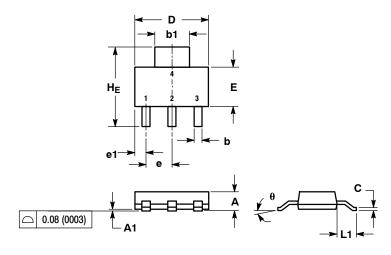


Figure 7. Typical Holding Current

Figure 8. Power Dissipation

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUF M



NOTES

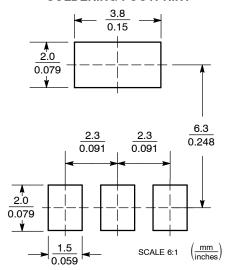
DIMENSIONING AND TOLERANCING PER ANSI 1. DIIVIL... Y14.5M, 1982.

CONTROLLING DIMENSION: INCH.

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 1.50 | 1.63 | 1.75 | 0.060 | 0.064 | 0.068 |
| A1 | 0.02 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.60 | 0.75 | 0.89 | 0.024 | 0.030 | 0.035 |
| b1 | 2.90 | 3.06 | 3.20 | 0.115 | 0.121 | 0.126 |
| С | 0.24 | 0.29 | 0.35 | 0.009 | 0.012 | 0.014 |
| D | 6.30 | 6.50 | 6.70 | 0.249 | 0.256 | 0.263 |
| E | 3.30 | 3.50 | 3.70 | 0.130 | 0.138 | 0.145 |
| е | 2.20 | 2.30 | 2.40 | 0.087 | 0.091 | 0.094 |
| e1 | 0.85 | 0.94 | 1.05 | 0.033 | 0.037 | 0.041 |
| L1 | 1.50 | 1.75 | 2.00 | 0.060 | 0.069 | 0.078 |
| HE | 6.70 | 7.00 | 7.30 | 0.264 | 0.276 | 0.287 |
| θ | 0° | - | 10° | 0° | - | 10° |

STYLE 11: PIN 1. MT 1 2. MT 2 3. GATE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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